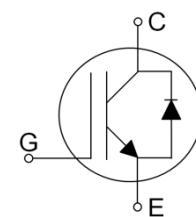
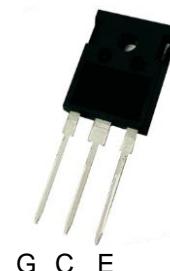


## Features

- 1350V Reverse Conducting Field Stop Trench Technology
- Excellent EMI Behavior
- High Speed Switching
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy Parallel Operation
- 175°C Operating Temperature
- RoHS Compliant
- JEDEC Qualification

TO-247



## Applications

- Induction Heating
- Inverterized microwave ovens
- Soft Switching Applications

Device	Package	Marking	Remark
TGH20S135FD	TO-247	TGH20S135FD	RoHS

## Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	1350	V
Gate-Emitter Voltage	$V_{GES}$	$\pm 25$	V
Continuous Collector Current $T_C = 25^\circ\text{C}$	$I_C$	40	A
		20	
Pulsed Collector Current (Note 1)	$I_{CM}$	100	A
Diode Continuous Forward Current	$I_F$	20	A
Power Dissipation $T_C = 25^\circ\text{C}$	$P_D$	242	W
		121	
Operating Junction Temperature	$T_{vj}$	-55 ~ 175	°C
Storage Temperature Range	$T_{STG}$	-55 ~ 150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	300	°C

Notes :

- (1) Repetitive rating : Pulse width limited by maximum junction temperature , During production, high current switching capability is 100% verified with the inductive load single-pulse switching test. ( $I_C = 100\text{A}$ )

## Thermal Characteristics

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.62	°C/W
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (DIODE)	0.62	°C/W
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	40	°C/W

**Electrical Characteristics**  $T_{vj}=25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
<b>OFF</b>						
Collector – Emitter Breakdown Voltage	$\text{BV}_{\text{CES}}$	$V_{\text{GE}} = 0\text{V}, I_{\text{C}} = 1\text{mA}$	1350	--	--	V
Zero Gate Voltage Collector Current	$I_{\text{CES}}$	$V_{\text{CE}} = 1350\text{V}, V_{\text{GE}} = 0\text{V}$	--	--	1	mA
Gate – Emitter Leakage Current	$I_{\text{GES}}$	$V_{\text{CE}} = 0\text{V}, V_{\text{GE}} = \pm 25\text{V}$	--	--	$\pm 500$	nA
Integrated Gate Resistor	$R_{\text{G(int)}}$	$f = 1\text{MHz}$ , open Collector	--	21	--	$\Omega$
<b>ON</b>						
Gate – Emitter Threshold Voltage	$V_{\text{GE(TH)}}$	$V_{\text{GE}} = V_{\text{CE}}, I_{\text{C}} = 20\text{mA}$	4.0	6.0	8.0	V
Collector – Emitter Saturation Voltage	$V_{\text{CE(SAT)}}$	$V_{\text{GE}} = 15\text{V}, I_{\text{C}} = 20\text{A}, T_{vj} = 25^\circ\text{C}$	--	1.75	2.15	V
		$V_{\text{GE}} = 15\text{V}, I_{\text{C}} = 20\text{A}, T_{vj} = 125^\circ\text{C}$	--	2.04	--	V
		$V_{\text{GE}} = 15\text{V}, I_{\text{C}} = 20\text{A}, T_{vj} = 175^\circ\text{C}$	--	2.23	--	V
Diode Forward Voltage	$V_{\text{FM}}$	$I_F = 20\text{A}, T_{vj} = 25^\circ\text{C}$	--	2.25	--	V
		$I_F = 20\text{A}, T_{vj} = 125^\circ\text{C}$	--	2.43	--	V
		$I_F = 20\text{A}, T_{vj} = 175^\circ\text{C}$	--	2.53	--	V
<b>DYNAMIC</b>						
Input Capacitance	$C_{\text{IES}}$	$V_{\text{CE}} = 30\text{V}, V_{\text{GE}} = 0\text{V}$ $f = 1\text{MHz}$	--	2036	--	pF
Output Capacitance	$C_{\text{OES}}$		--	42	--	pF
Reverse Transfer Capacitance	$C_{\text{RES}}$		--	30	--	pF
Total Gate Charge	$Q_g$	$V_{\text{CC}} = 600\text{V}, I_{\text{C}} = 20\text{A}$ $V_{\text{GE}} = 15\text{V}$	--	115	172	nC
Gate-Emitter Charge	$Q_{\text{ge}}$		--	17	25	nC
Gate-Collector Charge	$Q_{\text{gc}}$		--	46	69	nC

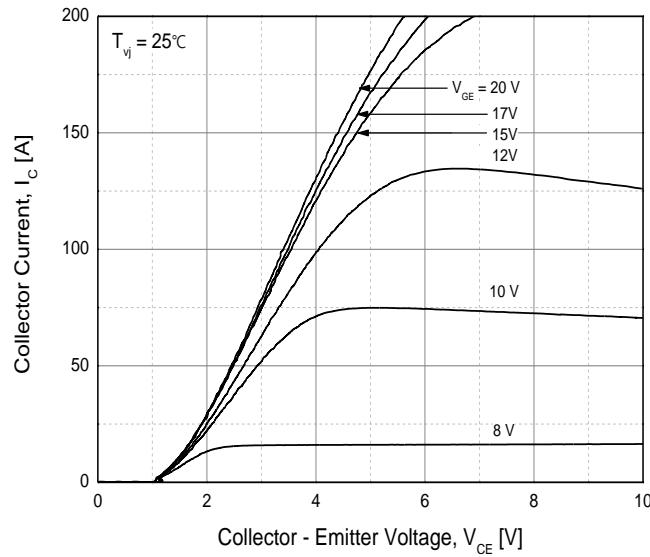
Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
<b>SWITCHING</b> (Note 2)						
Turn-Off Delay Time	$t_{d(off)}$	$V_{CC} = 600V, I_C = 10A$ $R_G = R_{G(int)}, V_{GE} = 15V$ Inductive Load, $T_{vj} = 25^\circ C$	--	142	--	ns
Fall Time	$t_f$		--	106	159	ns
Turn-Off Switching Loss	$E_{OFF}$		--	0.18	0.27	mJ
Turn-Off Delay Time	$t_{d(off)}$	$V_{CC} = 600V, I_C = 20A$ $R_G = R_{G(int)}, V_{GE} = 15V$ Inductive Load, $T_{vj} = 25^\circ C$	--	142	--	ns
Fall Time	$t_f$		--	93	140	ns
Turn-Off Switching Loss	$E_{OFF}$		--	0.50	0.75	mJ
Turn-Off Delay Time	$t_{d(off)}$	$V_{CC} = 600V, I_C = 10A$ $R_G = R_{G(int)}, V_{GE} = 15V$ Inductive Load, $T_{vj} = 175^\circ C$	--	173	--	ns
Fall Time	$t_f$		--	191	--	ns
Turn-Off Switching Loss	$E_{OFF}$		--	0.34	0.51	mJ
Turn-Off Delay Time	$t_{d(off)}$	$V_{CC} = 600V, I_C = 20A$ $R_G = R_{G(int)}, V_{GE} = 15V$ Inductive Load, $T_{vj} = 175^\circ C$	--	169	--	ns
Fall Time	$t_f$		--	186	--	ns
Turn-Off Switching Loss	$E_{OFF}$		--	0.89	1.34	mJ

Notes :

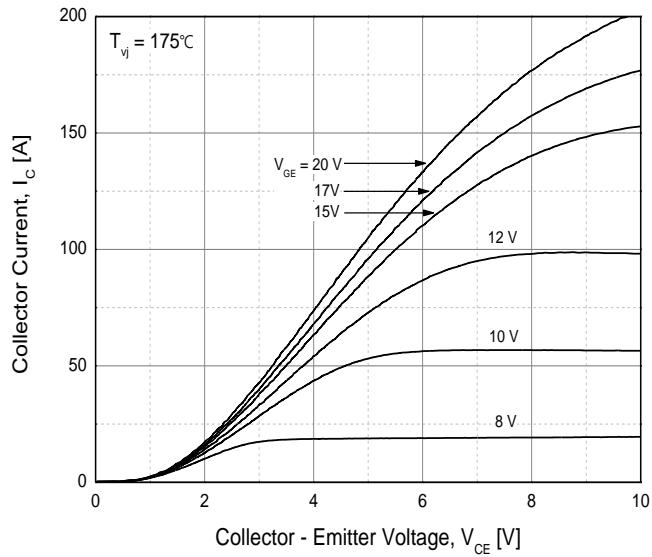
(2) Not subject to production test – verified by design/characterization

## Device Characteristics

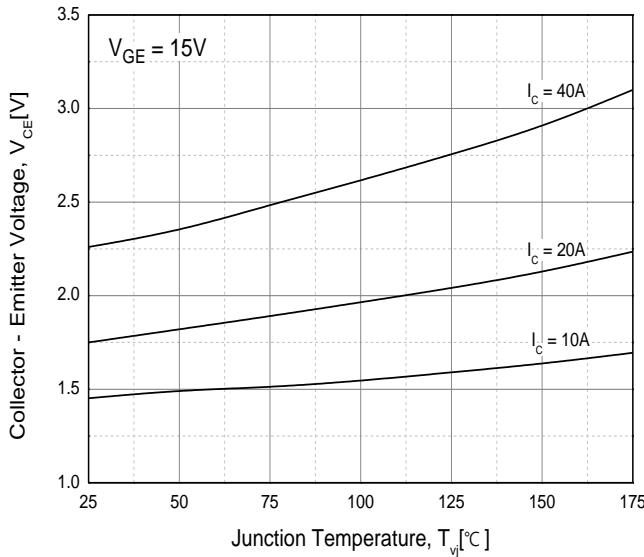
**Figure 1. IGBT Output Characteristics**



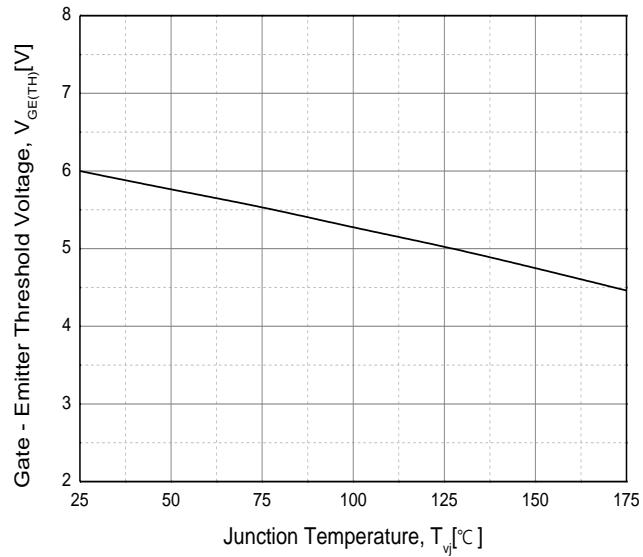
**Figure 2. IGBT Output Characteristics**



**Figure 3. IGBT Saturation Voltage  
vs. Junction Temperature**

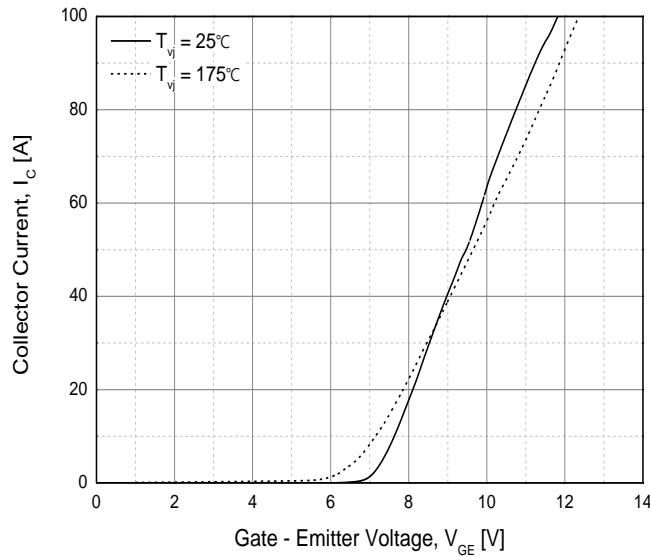


**Figure 4. IGBT Threshold Voltage  
vs. Junction Temperature**

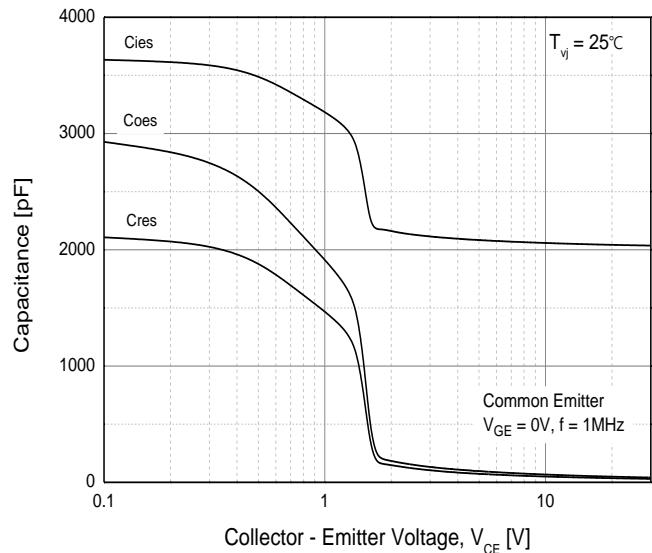


## Device Characteristics

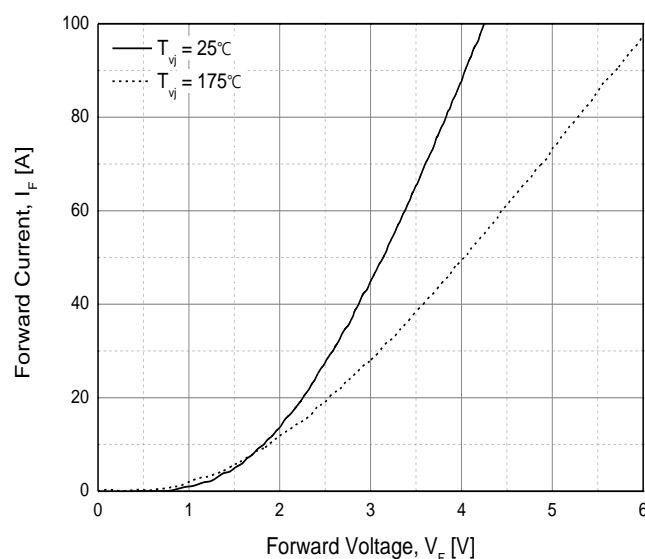
**Figure 5. IGBT Transfer Characteristics**



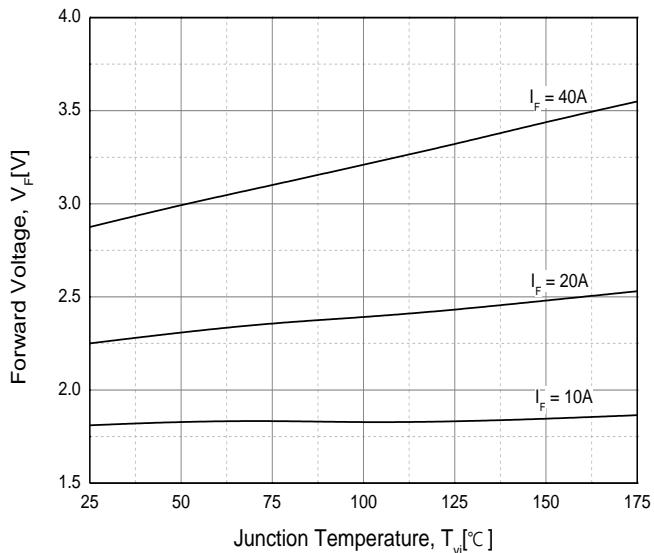
**Figure 6. IGBT Capacitance Characteristics**



**Figure 7. Diode Conduction Characteristics**



**Figure 8. Diode Forward Voltage vs. Junction Temperature**



## Device Characteristics

Fig. 9 Turn-off Time vs. Gate Resistor

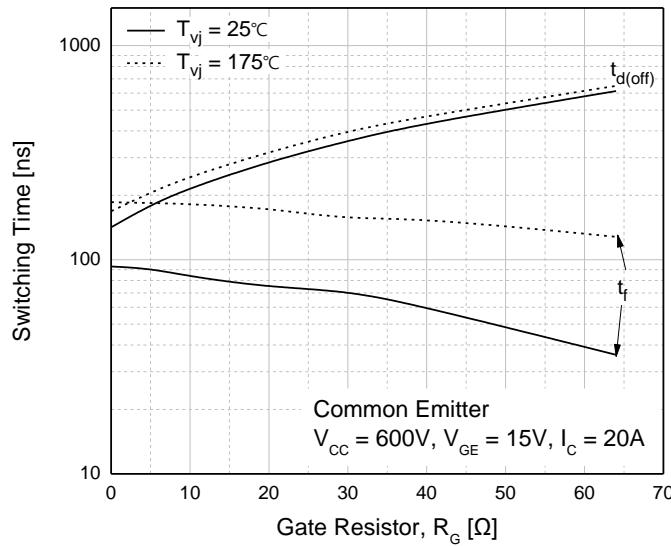


Fig. 10 Turn-off Time vs. Collector Current

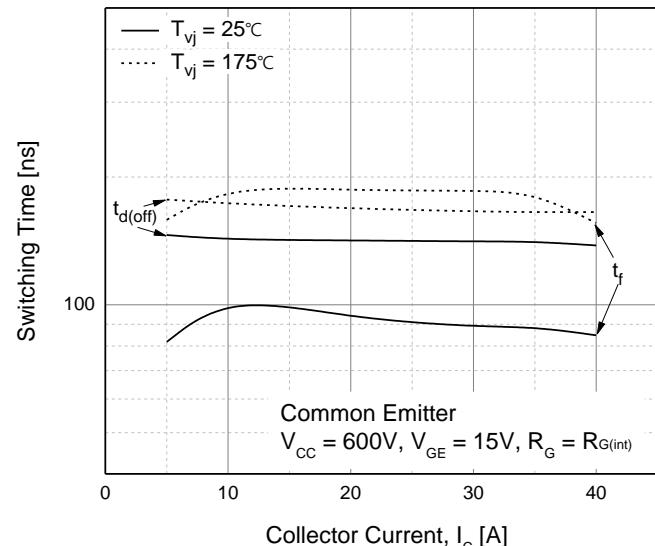


Fig. 11 Turn-off Loss vs. Gate Resistor

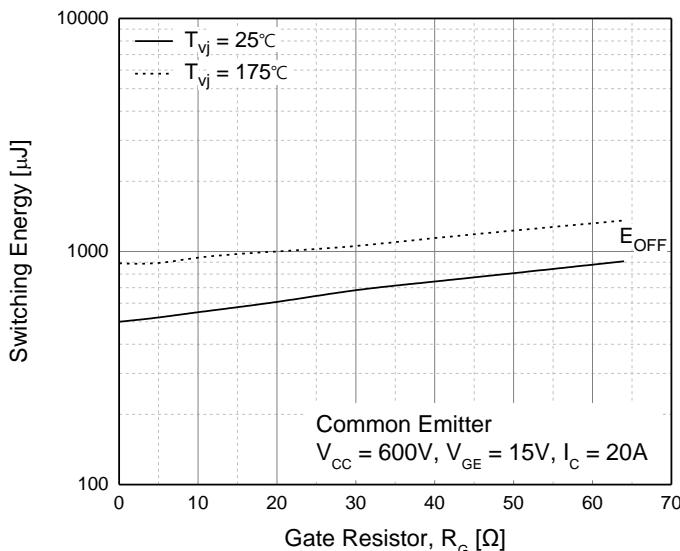
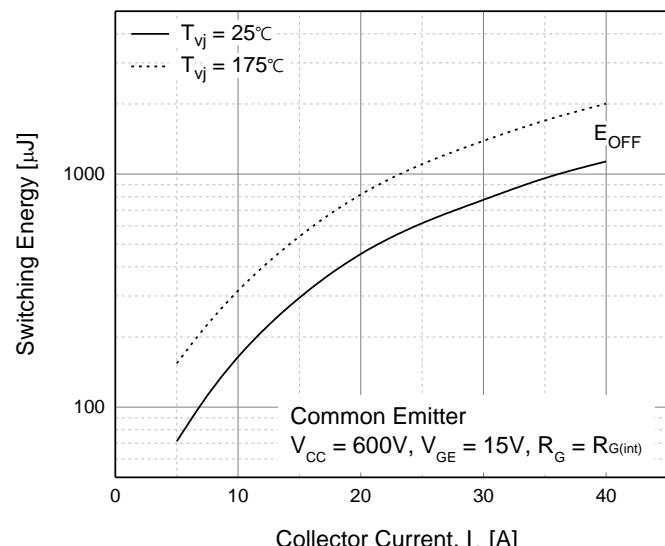
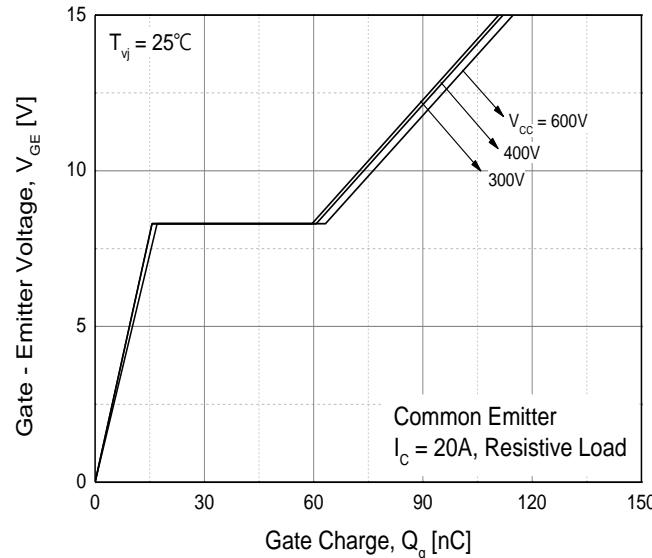


Fig. 12 Turn-off Loss vs. Collector Current

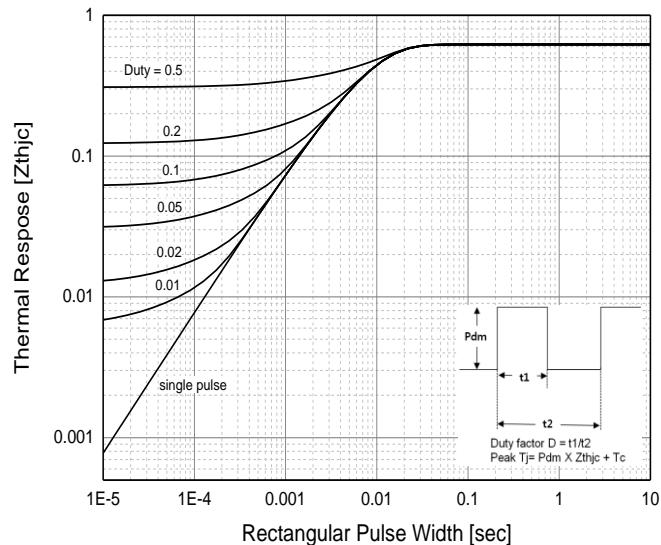


## Device Characteristics

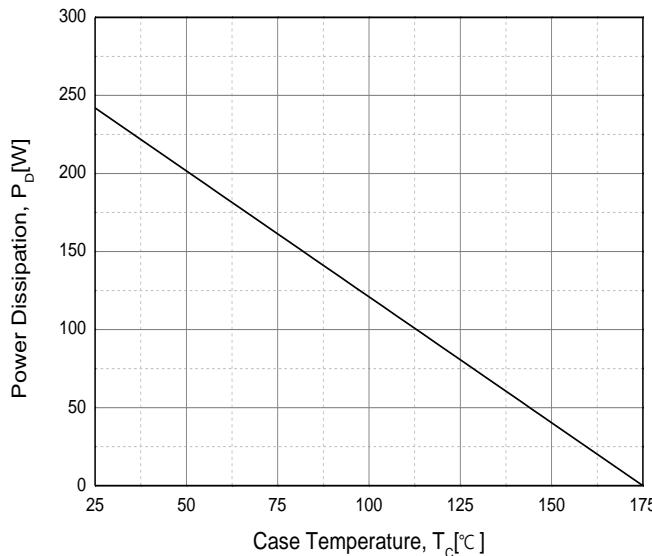
**Figure 13. Gate Charge Characteristics**



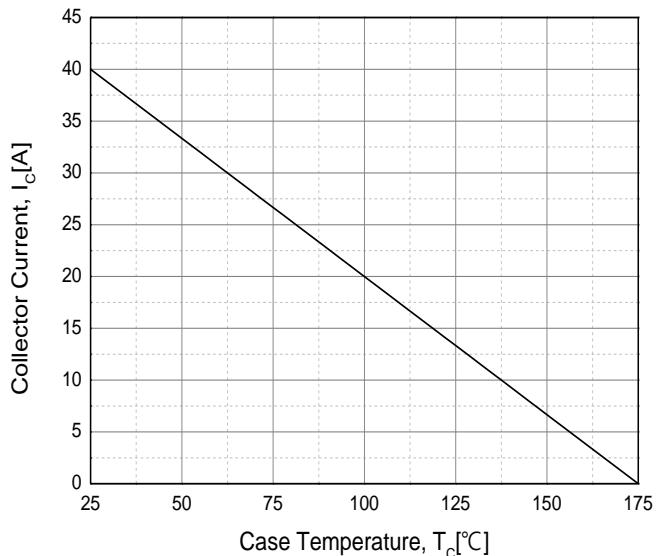
**Figure 14. Transient Thermal Impedance**



**Figure 15. Power Dissipation vs. Case Temperature**



**Figure 16. Collector Current vs. Case Temperature**



## Device Characteristics

Fig. 17 SOA

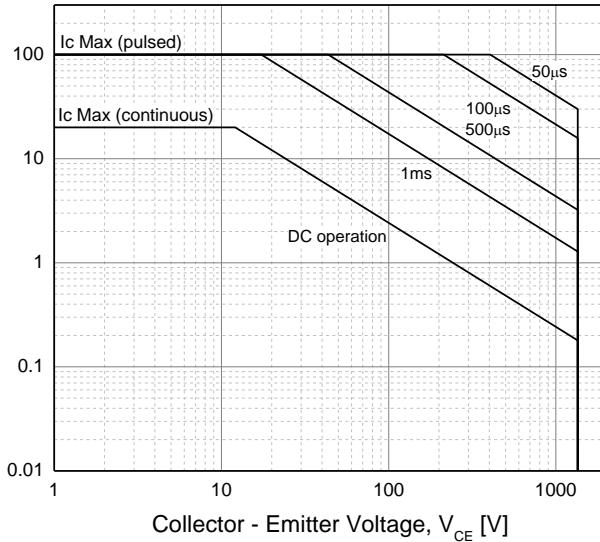


Fig. 18 RBSOA

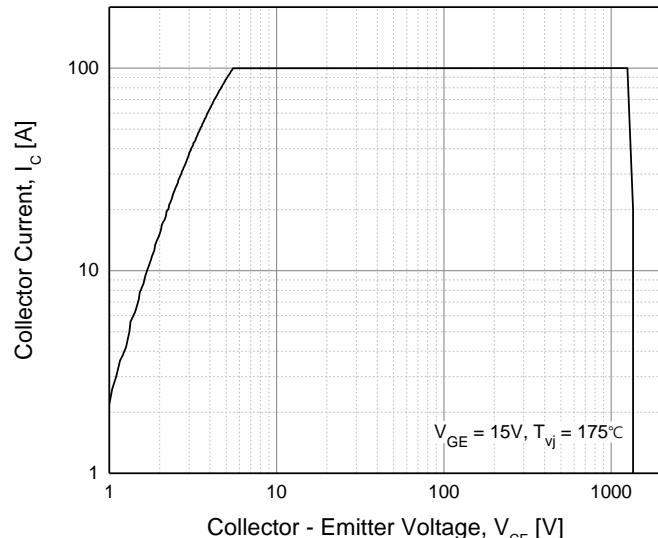


Fig. 19 Load Current vs. Frequency

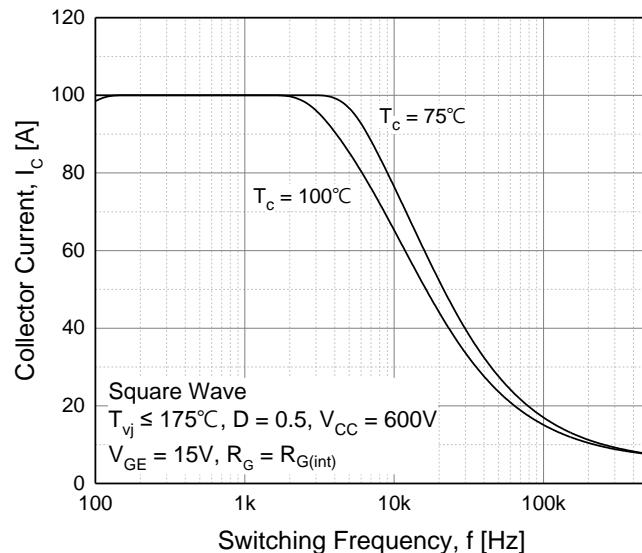
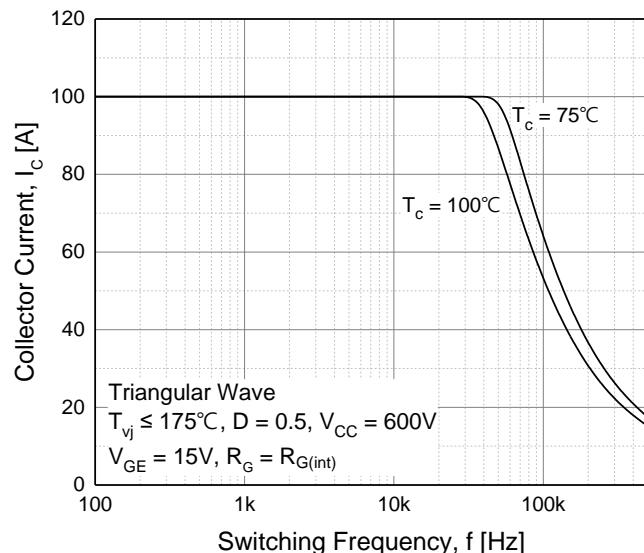
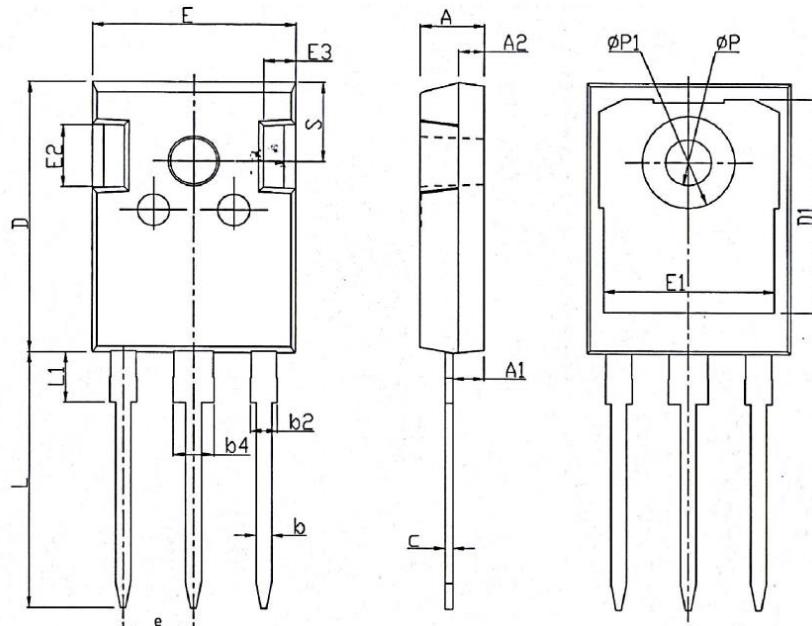


Fig. 20 Load Current vs. Frequency



## TO-247 MECHANICAL DATA



SYMBOL	mm		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.80	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.62	19.92	20.22
L1	-	-	4.30
ΦP	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		

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